

MADP-011201 Series

Rev. V1

Features

- Cost Effective Choice for Switch Applications
- · Broadband Performance up to 3 GHz
- IIP3: 80 dBm
- Low Insertion Loss: 0.25 dB
- Supports Power up to 2 W (DFN-0402) or 3 W (DFN-2012)
- Small Size
 - DFN-0402 = 40 x 24 mils
 - DFN-2012 = 1.9 x 1.1 mm
- RoHS* Compliant

Applications

 Wireless Telecommunications Infrastructure & Test Instrument Applications

Description

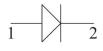
The MADP-011201 is a high linearity, medium power AlGaAs PIN diode element offered in a Lead-free, surface mount plastic package. The Series Switch Configuration has a body size of 40 x 24 mils, while the Shunt Switch Configuration has a body size of 1.9 x 1.1 mm.

This AlGaAs PIN diode is designed for wireless telecommunications infrastructure & test instrument applications. It is also well suited for other applications in $0.1 \sim 3.0$ GHz.

Ordering Information

Part Number	Packaging	
MADP-011201-0402P	1,000 pc Reel	
MADP-011201-2012	1,000 pc Reel	

Pin Out / Schematic





(0402)





(2012)

Pin Configuration (2012)¹

Pin #	Pin Name	Description
1	RF _{IN}	RF Input
2	RF _{OUT}	RF Output
3	Paddle ²	Ground

- MACOM recommends connecting unused package pins to ground.
- The exposed pad centered on the package bottom must be connected to RF, DC and thermal ground.

^{*} Restrictions on Hazardous Substances, compliant to current RoHS EU directive.



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Electrical Specifications: T_A = +25°C

Parameter	Test Conditions	Min.	Тур.	Max.	Units
Breakdown Voltage (V _B)	I _R = 10 μA	150	_	_	V
Forward Voltage (V _F)	I _F = 50 mA	_	1.4	1.5	V
Total Capacitance (C _T)	V _R = -50 V, 1 MHz	_	0.20	0.26	pF
Series Resistance (R _S)	If = 10 mA, 100 MHz	_	1.5	_	Ω
Minority Carrier Lifetime (T _L)	I _F = 10 mA, I _R = 6 mA @ 90% Recovery	_	80	_	ns

Absolute Maximum Ratings^{3,4}

Parameter	Absolute Maximum		
Breakdown Voltage	150 V		
Forward Current	100 mA		
Thermal Resistance	58°C/W		
Junction Temperature	+175°C		
Storage Temperature	-65°C to +150°C		
Assembly Temperature	+260°C, Per JEDEC STD-J-20C		

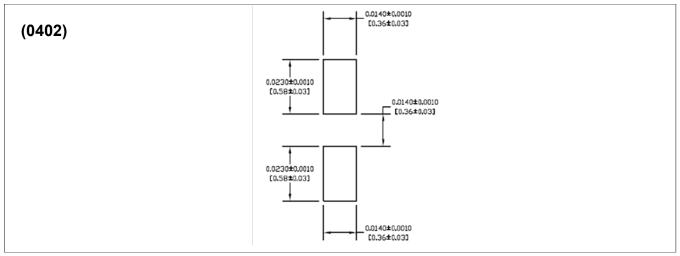
^{3.} Exceeding any one or combination of these limits may cause permanent damage to this device.

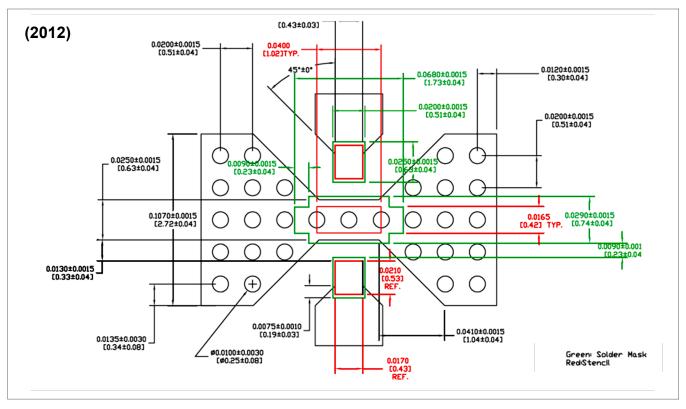
^{4.} MACOM does not recommend sustained operation near these survivability limits.



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Printed Circuit Board Layouts





NOTE: If possible, use copper filled vias underneath pin 3 for better thermals; otherwise, use vias that are plated through, filled and plated over.

Solder mask should provide a 60 um clearance between copper pad and solder mask. Rounded pkg pads should have matching rounded solder mask openings.

Use circles or squares for the thermal land stencil such that only get 50% to 80% solder paste coverage.

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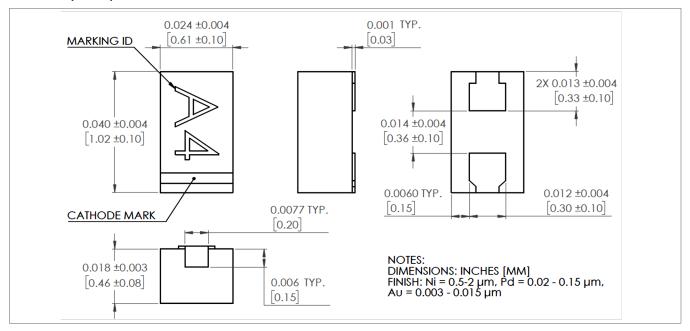
3



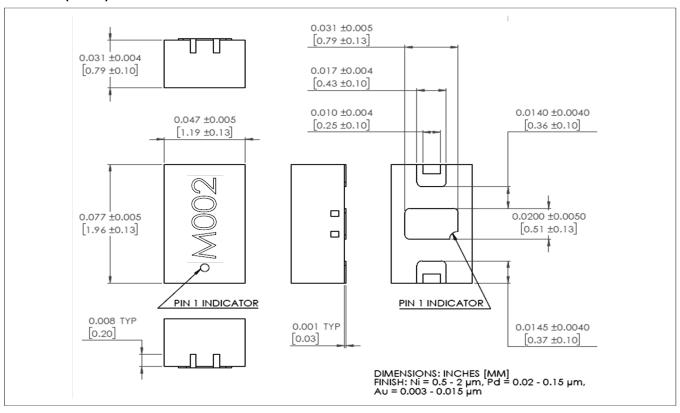
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Outline (0402)



Outline (2012)





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